

VBFB1410 Datasheet

N-Channel 40 V (D-S) MOSFET

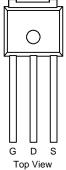
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)	
40	0.0F3 at V _{GS} = 10 V	55 ^d	F9.5	
70	0.0FI at V _{GS} = 4.5 V	I 5 ^d	19.5	

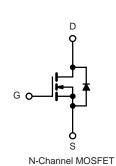
FEATURES

- · Halogen-free According to IEC 61249-2-21 Definition
- VBmos® Trench Cell
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC









APPLICATIONS

- · Power Supply
 - Secondary Synchronous Rectification
- DC/DC Converter

ABSOLUTE MAXIMUM RATINGS	$T_C = 25 ^{\circ}C$, unless oth	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	40	V
Gate-Source Voltage		V _{GS}	± 20	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 25 °C	L	55 ^d	
Continuous Diam Current (1) = 130 C)	T _C = 70 °C	I _D	I 5 ^d	A
Pulsed Drain Current		I _{DM}	165	
Avalanche Current		I _{AS}	H4	
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	Ϊ8	mJ
Mariana Dania Dia inatiana	T _C = 25 °C	D	Í 5.5 ^b	10/
Maximum Power Dissipation ^a	T _A = 25 °C ^c	P _D	2.7	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	ĺ4	°C/W
Junction-to-Case (Drain)	R _{thJC}	2.Ï	C/VV

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	V _{DS} = 0 V, I _D = 250 μA	40			١/
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.5	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA
		V _{DS} = 40V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40V, V _{GS} = 0 V, T _J = 125 °C			50	μA
		V _{DS} = 40V , V _{GS} = 0 V, T _J = 150 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	55			Α
Drain-Source On-State Resistance ^a	В	V _{GS} = 10 V, I _D = 22 A		0.0F3		Ω
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 20 A		0.0FI		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		1€0		S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz		1100		pF
Output Capacitance	C _{oss}			460		
Reverse Transfer Capacitance	C _{rss}			350		
Total Gate Charge ^c		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 20 A		H6		
Total Gate Charge	Qg			25		~C
Gate-Source Charge ^c	Q_{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 20 A		Î		nC
Gate-Drain Charge ^c	Q_{gd}			ĺ.7		
Gate Resistance	R _g	f = 1 MHz	0.4	2	4	Ω
Turn-On Delay Time ^c	t _{d(on)}			8	16	
Rise Time ^c	t _r	V_{DD} = 15 V, R_{L} = 1.5 Ω		9	18	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		35	53	- ns
Fall Time ^c	t _f			9	18	
Drain-Source Body Diode Ratings a	nd Characteris	stics T _C = 25 °C ^b				
Continuous Current	I _S				55	
Pulsed Current	I _{SM}				165	Α
Forward Voltage ^a	V_{SD}	I _F = 10 A, V _{GS} = 0 V		0.75	1.5	V
Reverse Recovery Time	t _{rr}			34	51	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 10 A, dI/dt = 100 A/μs		2	3	Α
Reverse Recovery Charge	Q _{rr}			34	51	nC

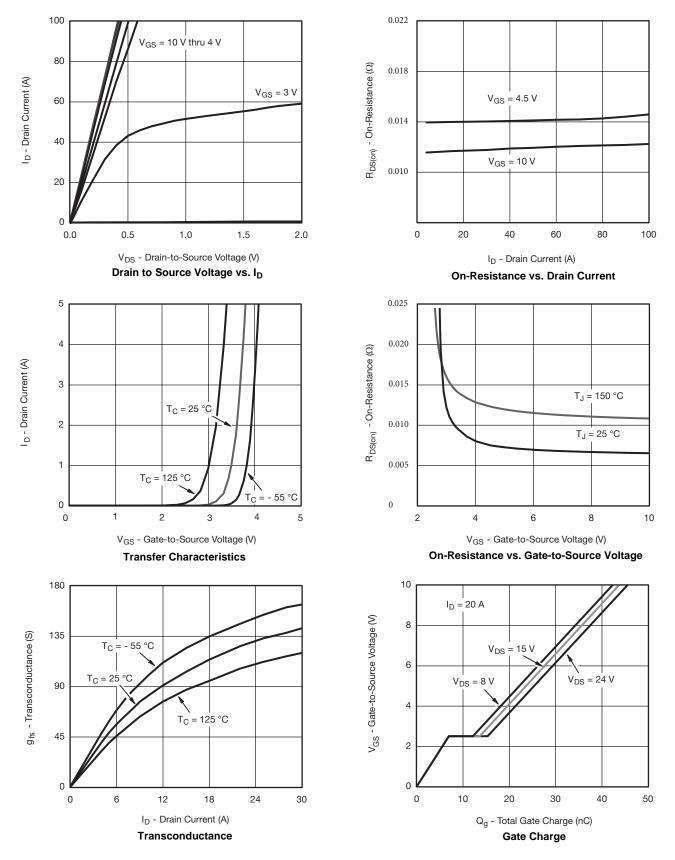
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

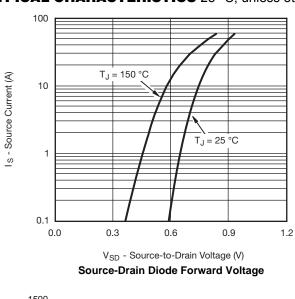


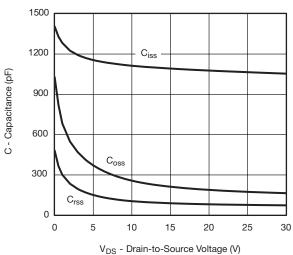
TYPICAL CHARACTERISTICS 25 C, unless otherwise noted



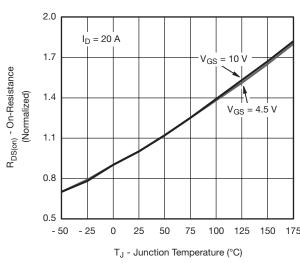


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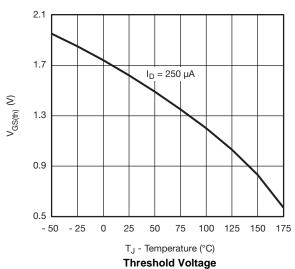


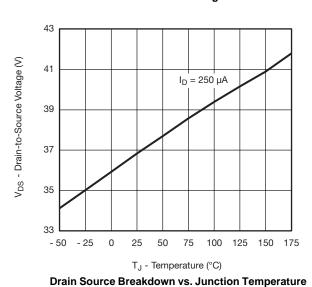


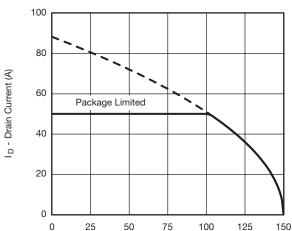
Capacitance







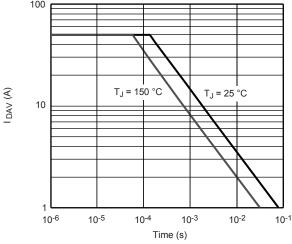


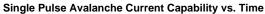


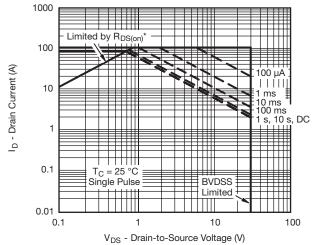
Current Derating



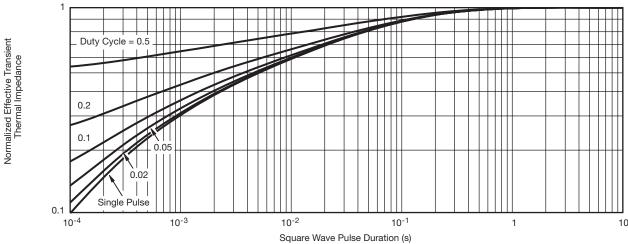
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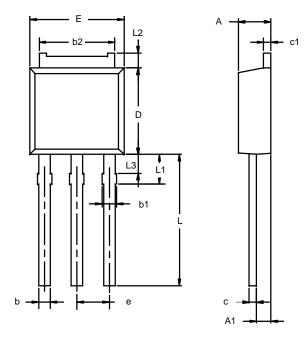
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified **Safe Operating Area**



Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA



Note:	Dimension	I 3 is for	reference	only

	MILLIMETERS		INCHES		
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A 1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
с1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28	2.28 BSC		BSC	
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	

DWG: 5346



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